

# Global Wafer Bonding Equipment Competitive Landscape Professional Research Report 2025

<https://marketpublishers.com/r/WC616E404329EN.html>

Date: June 2025

Pages: 165

Price: US\$ 3,500.00 (Single User License)

ID: WC616E404329EN

## Abstracts

### Market Overview

According to DIResearch's in-depth investigation and research, the global Wafer Bonding Equipment market size will reach 359.86 Million USD in 2025 and is projected to reach 501.65 Million USD by 2032, with a CAGR of 4.86% (2025-2032). Notably, the China Wafer Bonding Equipment market has changed rapidly in the past few years. By 2025, China's market size is expected to be Million USD, representing approximately % of the global market share.

### Research Summary

Wafer bonding equipment refers to machinery and tools used in the process of bonding or joining semiconductor wafers together to create complex structures or integrated circuits. This bonding process plays a crucial role in the fabrication of advanced semiconductor devices such as MEMS (Micro-Electro-Mechanical Systems), 3D integrated circuits, and compound semiconductor devices. Wafer bonding equipment typically includes specialized machines and tools designed to facilitate various bonding techniques, such as direct bonding, adhesive bonding, fusion bonding, and eutectic bonding. These machines often feature precise alignment systems, controlled heating and cooling mechanisms, and vacuum chambers to ensure the successful bonding of wafers with high accuracy and reliability. Wafer bonding equipment is essential in semiconductor manufacturing, enabling the integration of multiple layers of materials and functionalities on a single semiconductor substrate, thereby enhancing device performance and functionality.

The major global manufacturers of Wafer Bonding Equipment include EV Group, SUSS

MicroTec, Tokyo Electron, Applied Microengineering, Nidec Machinetool, Ayumi Industry, Shanghai Micro Electronics, U-Precision Tech, Hutem, Canon, Bondtech, TAZMO, TOK, etc. The global players competition landscape in this report is divided into three tiers. The first tier comprises global leading enterprises that command a substantial market share, hold a dominant industry position, possess strong competitiveness and influence, and generate significant revenue. The second tier includes companies with a notable market presence and reputation; these firms actively follow industry leaders in product, service, or technological innovation and maintain a moderate revenue scale. The third tier consists of smaller companies with limited market share and lower brand recognition, primarily focused on local markets and generating comparatively lower revenue.

This report studies the market size, price trends and future development prospects of Wafer Bonding Equipment. Focus on analysing the market share, product portfolio, prices, sales, revenue and gross profit margin of global major manufacturers, as well as the market status and trends of different product types and applications in the global Wafer Bonding Equipment market. The report data covers historical data from 2020 to 2024, based year in 2025 and forecast data from 2026 to 2032.

The regions and countries in the report include North America, Europe, China, APAC (excl. China), Latin America and Middle East and Africa, covering the Wafer Bonding Equipment market conditions and future development trends of key regions and countries, combined with industry-related policies and the latest technological developments, analyze the development characteristics of Wafer Bonding Equipment industries in various regions and countries, help companies understand the development characteristics of each region, help companies formulate business strategies, and achieve the ultimate goal of the company's global development strategy.

The data sources of this report mainly include the National Bureau of Statistics, customs databases, industry associations, corporate financial reports, third-party databases, etc. Among them, macroeconomic data mainly comes from the National Bureau of Statistics, International Economic Research Organization; industry statistical data mainly come from industry associations; company data mainly comes from interviews, public information collection, third-party reliable databases, and price data mainly comes from various markets monitoring database.

Global Key Manufacturers of Wafer Bonding Equipment Include:

EV Group

SUSS MicroTec

Tokyo Electron

Applied Microengineering

Nidec Machinetool

Ayumi Industry

Shanghai Micro Electronics

U-Precision Tech

Hutem

Canon

Bondtech

TAZMO

TOK

Wafer Bonding Equipment Product Segment Include:

Fully Automatic Equipment

Semi Automatic Equipment

Wafer Bonding Equipment Product Application Include:

MEMS

Advanced Packaging

CIS

Others

## **Chapter Scope**

Chapter 1: Product Research Range, Product Types and Applications, Market Overview, Market Situation and Trends

Chapter 2: Global Wafer Bonding Equipment Industry PESTEL Analysis

Chapter 3: Global Wafer Bonding Equipment Industry Porter's Five Forces Analysis

Chapter 4: Global Wafer Bonding Equipment Major Regional Market Size (Revenue, Sales, Price) and Forecast Analysis

Chapter 5: Global Wafer Bonding Equipment Market Size and Forecast by Type and Application Analysis

Chapter 6: North America Wafer Bonding Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 7: Europe Wafer Bonding Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 8: China Wafer Bonding Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 9: APAC (Excl. China) Wafer Bonding Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 10: Latin America Wafer Bonding Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 11: Middle East and Africa Wafer Bonding Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 12: Global Wafer Bonding Equipment Competitive Analysis of Key Manufacturers (Sales, Revenue, Market Share, Price, Regional Distribution and Industry Concentration)

Chapter 13: Key Company Profiles (Product Portfolio, Sales, Revenue, Price and Gross Margin)

Chapter 14: Industrial Chain Analysis, Include Raw Material Suppliers, Distributors and Customers

Chapter 15: Research Findings and Conclusion

Chapter 16: Methodology and Data Sources

## Contents

### **1 WAFER BONDING EQUIPMENT MARKET OVERVIEW**

- 1.1 Product Definition and Statistical Scope
- 1.2 Wafer Bonding Equipment Product by Type
  - 1.2.1 Fully Automatic Equipment
  - 1.2.2 Semi Automatic Equipment
- 1.3 Wafer Bonding Equipment Product by Application
  - 1.3.1 MEMS
  - 1.3.2 Advanced Packaging
  - 1.3.3 CIS
  - 1.3.4 Others
- 1.4 Global Wafer Bonding Equipment Market Revenue and Sales Analysis
  - 1.4.1 Global Wafer Bonding Equipment Revenue Market Size Analysis (2020-2032)
  - 1.4.2 Global Wafer Bonding Equipment Sales Market Size Analysis (2020-2032)
  - 1.4.3 Global Wafer Bonding Equipment Market Sales Price Trend Analysis (2020-2032)
- 1.5 Wafer Bonding Equipment Industry Trends and Innovation
  - 1.5.1 Wafer Bonding Equipment Industry Trends and Innovation
  - 1.5.2 Wafer Bonding Equipment Market Drivers and Challenges

### **2 WAFER BONDING EQUIPMENT MARKET PESTEL ANALYSIS**

- 2.1 Political Factors Analysis
- 2.2 Economic Factors Analysis
- 2.3 Social Factors Analysis
- 2.4 Technological Factors Analysis
- 2.5 Environmental Factors Analysis
- 2.6 Legal Factors Analysis

### **3 WAFER BONDING EQUIPMENT MARKET PORTER'S FIVE FORCES ANALYSIS**

- 3.1 Competitive Rivalry
- 3.2 Threat of New Entrants
- 3.3 Bargaining Power of Suppliers
- 3.4 Bargaining Power of Buyers
- 3.5 Threat of Substitutes

## **4 GLOBAL WAFER BONDING EQUIPMENT MARKET ANALYSIS BY REGIONS**

4.1 Wafer Bonding Equipment Overall Market: 2024 VS 2025 VS 2032

4.2 Global Wafer Bonding Equipment Revenue and Forecast Analysis (2020-2032)

4.2.1 Global Wafer Bonding Equipment Revenue and Market Share by Region (2020-2025)

4.2.2 Global Wafer Bonding Equipment Revenue and Market Share Forecast by Region (2026-2032)

4.3 Global Wafer Bonding Equipment Sales and Forecast Analysis (2020-2032)

4.3.1 Global Wafer Bonding Equipment Sales and Market Share by Region (2020-2025)

4.3.2 Global Wafer Bonding Equipment Sales and Market Share Forecast by Region (2026-2032)

4.4 Global Wafer Bonding Equipment Sales Price Trend Analysis (2020-2032)

## **5 GLOBAL WAFER BONDING EQUIPMENT MARKET SIZE BY TYPE AND APPLICATION**

5.1 Global Wafer Bonding Equipment Market Size by Type

5.1.1 Global Wafer Bonding Equipment Revenue and Forecast Analysis by Type (2020-2032)

5.1.2 Global Wafer Bonding Equipment Sales and Forecast Analysis by Type (2020-2032)

5.2 Global Wafer Bonding Equipment Market Size by Application

5.2.1 Global Wafer Bonding Equipment Revenue and Forecast Analysis by Application (2020-2032)

5.2.2 Global Wafer Bonding Equipment Sales and Forecast Analysis by Application (2020-2032)

## **6 NORTH AMERICA**

6.1 North America Wafer Bonding Equipment Market Size and Growth Rate Analysis (2020-2032)

6.2 North America Key Manufacturers Analysis

6.3 North America Wafer Bonding Equipment Market Size by Type

6.3.1 North America Wafer Bonding Equipment Sales by Type (2020-2032)

6.3.2 North America Wafer Bonding Equipment Revenue by Type (2020-2032)

6.4 North America Wafer Bonding Equipment Market Size by Application

6.4.1 North America Wafer Bonding Equipment Sales by Application (2020-2032)

- 6.4.2 North America Wafer Bonding Equipment Revenue by Application (2020-2032)
- 6.5 North America Wafer Bonding Equipment Market Size by Country
  - 6.5.1 US
  - 6.5.2 Canada

## **7 EUROPE**

- 7.1 Europe Wafer Bonding Equipment Market Size and Growth Rate Analysis (2020-2032)
- 7.2 Europe Key Manufacturers Analysis
- 7.3 Europe Wafer Bonding Equipment Market Size by Type
  - 7.3.1 Europe Wafer Bonding Equipment Sales by Type (2020-2032)
  - 7.3.2 Europe Wafer Bonding Equipment Revenue by Type (2020-2032)
- 7.4 Europe Wafer Bonding Equipment Market Size by Application
  - 7.4.1 Europe Wafer Bonding Equipment Sales by Application (2020-2032)
  - 7.4.2 Europe Wafer Bonding Equipment Revenue by Application (2020-2032)
- 7.5 Europe Wafer Bonding Equipment Market Size by Country
  - 7.5.1 Germany
  - 7.5.2 France
  - 7.5.3 United Kingdom
  - 7.5.4 Italy
  - 7.5.5 Spain
  - 7.5.6 Benelux

## **8 CHINA**

- 8.1 China Wafer Bonding Equipment Market Size and Growth Rate Analysis (2020-2032)
- 8.2 China Key Manufacturers Analysis
- 8.3 China Wafer Bonding Equipment Market Size by Type
  - 8.3.1 China Wafer Bonding Equipment Sales by Type (2020-2032)
  - 8.3.2 China Wafer Bonding Equipment Revenue by Type (2020-2032)
- 8.4 China Wafer Bonding Equipment Market Size by Application
  - 8.4.1 China Wafer Bonding Equipment Sales by Application (2020-2032)
  - 8.4.2 China Wafer Bonding Equipment Revenue by Application (2020-2032)

## **9 APAC (EXCL. CHINA)**

- 9.1 APAC (excl. China) Wafer Bonding Equipment Market Size and Growth Rate

Analysis (2020-2032)

9.2 APAC (excl. China) Key Manufacturers Analysis

9.3 APAC (excl. China) Wafer Bonding Equipment Market Size by Type

9.3.1 APAC (excl. China) Wafer Bonding Equipment Sales by Type (2020-2032)

9.3.2 APAC (excl. China) Wafer Bonding Equipment Revenue by Type (2020-2032)

9.4 APAC (excl. China) Wafer Bonding Equipment Market Size by Application

9.4.1 APAC (excl. China) Wafer Bonding Equipment Sales by Application (2020-2032)

9.4.2 APAC (excl. China) Wafer Bonding Equipment Revenue by Application

(2020-2032)

9.5 APAC (excl. China) Wafer Bonding Equipment Market Size by Country

9.5.1 Japan

9.5.2 South Korea

9.5.3 India

9.5.4 Australia

9.5.5 Southeast Asia

## **10 LATIN AMERICA**

10.1 Latin America Wafer Bonding Equipment Market Size and Growth Rate Analysis (2020-2032)

10.2 Latin America Key Manufacturers Analysis

10.3 Latin America Wafer Bonding Equipment Market Size by Type

10.3.1 Latin America Wafer Bonding Equipment Sales by Type (2020-2032)

10.3.2 Latin America Wafer Bonding Equipment Revenue by Type (2020-2032)

10.4 Latin America Wafer Bonding Equipment Market Size by Application

10.4.1 Latin America Wafer Bonding Equipment Sales by Application (2020-2032)

10.4.2 Latin America Wafer Bonding Equipment Revenue by Application (2020-2032)

10.5 Latin America Wafer Bonding Equipment Market Size by Country

10.6 Latin America Wafer Bonding Equipment Market Size by Country

10.6.1 Mexico

10.6.2 Brazil

## **11 MIDDLE EAST & AFRICA**

11.1 Middle East & Africa Wafer Bonding Equipment Market Size and Growth Rate Analysis (2020-2032)

11.2 Middle East & Africa Key Manufacturers Analysis

11.3 Middle East & Africa Wafer Bonding Equipment Market Size by Type

11.3.1 Middle East & Africa Wafer Bonding Equipment Sales by Type (2020-2032)

- 11.3.2 Middle East & Africa Wafer Bonding Equipment Revenue by Type (2020-2032)
- 11.4 Middle East & Africa Wafer Bonding Equipment Market Size by Application
  - 11.4.1 Middle East & Africa Wafer Bonding Equipment Sales by Application (2020-2032)
  - 11.4.2 Middle East & Africa Wafer Bonding Equipment Revenue by Application (2020-2032)
- 11.5 Middle East Wafer Bonding Equipment Market Size by Country
  - 11.5.1 Saudi Arabia
  - 11.5.2 South Africa

## **12 COMPETITION BY MANUFACTURERS**

- 12.1 Global Wafer Bonding Equipment Market Sales, Revenue and Price by Key Manufacturers (2021-2025)
  - 12.1.1 Global Wafer Bonding Equipment Market Sales by Key Manufacturers (2021-2025)
  - 12.1.2 Global Wafer Bonding Equipment Market Revenue by Key Manufacturers (2021-2025)
  - 12.1.3 Global Wafer Bonding Equipment Average Sales Price by Manufacturers (2021-2025)
- 12.2 Wafer Bonding Equipment Competitive Landscape Analysis and Market Dynamic
  - 12.2.1 Wafer Bonding Equipment Competitive Landscape Analysis
  - 12.2.2 Global Key Manufacturers Headquarter Location and Key Area Sales
  - 12.2.3 Market Dynamic

## **13 KEY COMPANIES ANALYSIS**

- 13.1 EV Group
  - 13.1.1 EV Group Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
  - 13.1.2 EV Group Wafer Bonding Equipment Product Portfolio
  - 13.1.3 EV Group Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.2 SUSS MicroTec
  - 13.2.1 SUSS MicroTec Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
  - 13.2.2 SUSS MicroTec Wafer Bonding Equipment Product Portfolio
  - 13.2.3 SUSS MicroTec Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

### 13.3 Tokyo Electron

13.3.1 Tokyo Electron Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

13.3.2 Tokyo Electron Wafer Bonding Equipment Product Portfolio

13.3.3 Tokyo Electron Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

### 13.4 Applied Microengineering

13.4.1 Applied Microengineering Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

13.4.2 Applied Microengineering Wafer Bonding Equipment Product Portfolio

13.4.3 Applied Microengineering Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

### 13.5 Nidec Machinetool

13.5.1 Nidec Machinetool Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

13.5.2 Nidec Machinetool Wafer Bonding Equipment Product Portfolio

13.5.3 Nidec Machinetool Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

### 13.6 Ayumi Industry

13.6.1 Ayumi Industry Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

13.6.2 Ayumi Industry Wafer Bonding Equipment Product Portfolio

13.6.3 Ayumi Industry Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

### 13.7 Shanghai Micro Electronics

13.7.1 Shanghai Micro Electronics Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

13.7.2 Shanghai Micro Electronics Wafer Bonding Equipment Product Portfolio

13.7.3 Shanghai Micro Electronics Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

### 13.8 U-Precision Tech

13.8.1 U-Precision Tech Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

13.8.2 U-Precision Tech Wafer Bonding Equipment Product Portfolio

13.8.3 U-Precision Tech Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

### 13.9 Hutem

13.9.1 Hutem Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

- 13.9.2 Hitem Wafer Bonding Equipment Product Portfolio
- 13.9.3 Hitem Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.10 Canon
  - 13.10.1 Canon Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
  - 13.10.2 Canon Wafer Bonding Equipment Product Portfolio
  - 13.10.3 Canon Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.11 Bondtech
  - 13.11.1 Bondtech Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
  - 13.11.2 Bondtech Wafer Bonding Equipment Product Portfolio
  - 13.11.3 Bondtech Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.12 TAZMO
  - 13.12.1 TAZMO Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
  - 13.12.2 TAZMO Wafer Bonding Equipment Product Portfolio
  - 13.12.3 TAZMO Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.13 TOK
  - 13.13.1 TOK Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
  - 13.13.2 TOK Wafer Bonding Equipment Product Portfolio
  - 13.13.3 TOK Wafer Bonding Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

## **14 INDUSTRY CHAIN ANALYSIS**

- 14.1 Wafer Bonding Equipment Industry Chain Analysis
- 14.2 Wafer Bonding Equipment Industry Raw Material and Suppliers Analysis
  - 14.2.1 Wafer Bonding Equipment Key Raw Material Supply Analysis
  - 14.2.2 Raw Material Suppliers and Contact Information
- 14.3 Wafer Bonding Equipment Typical Downstream Customers
- 14.4 Wafer Bonding Equipment Sales Channel Analysis

## **15 RESEARCH FINDINGS AND CONCLUSION**

## **16 METHODOLOGY AND DATA SOURCE**

16.1 Methodology/Research Approach

16.2 Research Scope

16.3 Benchmarks and Assumptions

16.4 Date Source

16.4.1 Primary Sources

16.4.2 Secondary Sources

16.5 Data Cross Validation

16.6 Disclaimer

## List Of Tables

### LIST OF TABLES

Table 1: Global Wafer Bonding Equipment Market Size Growth Rate by Type, 2024 VS 2025 VS 2032 (US\$ Million)

Table 2: Global Wafer Bonding Equipment Market Size Growth Rate by Application, 2024 VS 2025 VS 2032 (US\$ Million)

Table 3: Wafer Bonding Equipment Industry Development Status

Table 4: Wafer Bonding Equipment Industry Development Trends

Table 5: Global Wafer Bonding Equipment Market Size by Region in US\$ Million: 2024 VS 2025 VS 2032

Table 6: Global Wafer Bonding Equipment Revenue by Region (2020-2025) & (US\$ Million)

Table 7: Global Wafer Bonding Equipment Revenue Market Share by Region (2020-2025)

Table 8: Global Wafer Bonding Equipment Revenue Forecast by Region (2026-2032) & (US\$ Million)

Table 9: Global Wafer Bonding Equipment Revenue Market Share Forecast by Region (2026-2032)

Table 10: Global Wafer Bonding Equipment Sales by Region (2020-2025) & (Units)

Table 11: Global Wafer Bonding Equipment Sales Market Share by Region (2020-2025)

Table 12: Global Wafer Bonding Equipment Sales Forecast by Region (2026-2032) & (Units)

Table 13: Global Wafer Bonding Equipment Sales Market Share Forecast by Region (2026-2032)

Table 14: Global Wafer Bonding Equipment Revenue Analysis by Type (2020-2025) & (US\$ Million)

Table 15: Global Wafer Bonding Equipment Revenue Analysis Forecast by Type (2026-2032) & (US\$ Million)

Table 16: Global Wafer Bonding Equipment Sales Analysis by Type (2020-2025) & (Units)

Table 17: Global Wafer Bonding Equipment Sales Analysis Forecast by Type (2026-2032) & (Units)

Table 18: Global Wafer Bonding Equipment Revenue Analysis by Application (2020-2025) & (US\$ Million)

Table 19: Global Wafer Bonding Equipment Revenue Analysis Forecast by Application (2026-2032) & (US\$ Million)

Table 20: Global Wafer Bonding Equipment Sales Analysis by Application (2020-2025) & (Units)

Table 21: Global Wafer Bonding Equipment Sales Analysis Forecast by Application (2026-2032) & (Units)

Table 22: Key Wafer Bonding Equipment Players in North America

Table 23: North America Wafer Bonding Equipment Sales by Type (2020-2025) & (Units)

Table 24: North America Wafer Bonding Equipment Sales by Type (2026-2032) & (Units)

Table 25: North America Wafer Bonding Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 26: North America Wafer Bonding Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 27: North America Wafer Bonding Equipment Sales by Application (2020-2025) & (Units)

Table 28: North America Wafer Bonding Equipment Sales by Application (2026-2032) & (Units)

Table 29: North America Wafer Bonding Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 30: North America Wafer Bonding Equipment Revenue by Application (2026-2032) & (US\$ Million)

Table 31: North America Wafer Bonding Equipment Revenue Market Size by Country (2020-2025) & (US\$ Million)

Table 32: North America Wafer Bonding Equipment Revenue Market Size by Country (2026-2032) & (US\$ Million)

Table 33: North America Wafer Bonding Equipment Sales Market Size by Country (2020-2025) & (Units)

Table 34: North America Wafer Bonding Equipment Sales Market Size by Country (2026-2032) & (Units)

Table 35: Key Wafer Bonding Equipment Players in Europe

Table 36: Europe Wafer Bonding Equipment Sales by Type (2020-2025) & (Units)

Table 37: Europe Wafer Bonding Equipment Sales by Type (2026-2032) & (Units)

Table 38: Europe Wafer Bonding Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 39: Europe Wafer Bonding Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 40: Europe Wafer Bonding Equipment Sales by Application (2020-2025) & (Units)

Table 41: Europe Wafer Bonding Equipment Sales by Application (2026-2032) & (Units)

Table 42: Europe Wafer Bonding Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 43: Europe Wafer Bonding Equipment Revenue by Application (2026-2032) &

(US\$ Million)

Table 44: Europe Wafer Bonding Equipment Revenue Market Size by Country (2020-2025) & (US\$ Million)

Table 45: Europe Wafer Bonding Equipment Revenue Market Size Forecast by Country (2026-2032) & (US\$ Million)

Table 46: Europe Wafer Bonding Equipment Sales Market Size by Country (2020-2025) & (Units)

Table 47: Europe Wafer Bonding Equipment Sales Market Size Forecast by Country (2026-2032) & (Units)

Table 48: Key Wafer Bonding Equipment Players in China

Table 49: China Wafer Bonding Equipment Sales by Type (2020-2025) & (Units)

Table 50: China Wafer Bonding Equipment Sales by Type (2026-2032) & (Units)

Table 51: China Wafer Bonding Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 52: China Wafer Bonding Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 53: China Wafer Bonding Equipment Sales by Application (2020-2025) & (Units)

Table 54: China Wafer Bonding Equipment Sales by Application (2026-2032) & (Units)

Table 55: China Wafer Bonding Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 56: China Wafer Bonding Equipment Revenue by Application (2026-2032) & (US\$ Million)

Table 57: Key Wafer Bonding Equipment Players in APAC (excl. China)

Table 58: APAC (excl. China) Wafer Bonding Equipment Sales by Type (2020-2025) & (Units)

Table 59: APAC (excl. China) Wafer Bonding Equipment Sales by Type (2026-2032) & (Units)

Table 60: APAC (excl. China) Wafer Bonding Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 61: APAC (excl. China) Wafer Bonding Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 62: APAC (excl. China) Wafer Bonding Equipment Sales by Application (2020-2025) & (Units)

Table 63: APAC (excl. China) Wafer Bonding Equipment Sales by Application (2026-2032) & (Units)

Table 64: APAC (excl. China) Wafer Bonding Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 65: APAC (excl. China) Wafer Bonding Equipment Revenue by Application (2026-2032) & (US\$ Million)

Table 66:: APAC (excl. China) Wafer Bonding Equipment Revenue Market Size by Country (2020-2025) & (US\$ Million)

Table 67: APAC (excl. China) Wafer Bonding Equipment Revenue Market Size Forecast by Country (2026-2032) & (US\$ Million)

Table 68: APAC (excl. China) Wafer Bonding Equipment Sales Market Size by Country (2020-2025) & (Units)

Table 69: APAC (excl. China) Wafer Bonding Equipment Sales Market Size Forecast by Country (2026-2032) & (Units)

Table 70: Key Wafer Bonding Equipment Players in Latin America

Table 71: Latin America Wafer Bonding Equipment Sales by Type (2020-2025) & (Units)

Table 72: Latin America Wafer Bonding Equipment Sales by Type (2026-2032) & (Units)

Table 73: Latin America Wafer Bonding Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 74: Latin America Wafer Bonding Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 75: Latin America Wafer Bonding Equipment Sales by Application (2020-2025) & (Units)

Table 76: Latin America Wafer Bonding Equipment Sales by Application (2026-2032) & (Units)

Table 77: Latin America Wafer Bonding Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 78: Latin America Wafer Bonding Equipment Revenue by Application (2026-2032) & (US\$ Million)

Table 79: Latin America Wafer Bonding Equipment Revenue Market Size by Country (2020-2025) & (US\$ Million)

Table 80: Latin America Wafer Bonding Equipment Revenue Market Size Forecast by Country (2026-2032) & (US\$ Million)

Table 81: Latin America Wafer Bonding Equipment Sales Market Size by Country (2020-2025) & (Units)

Table 82: Latin America Wafer Bonding Equipment Sales Market Size Forecast by Country (2026-2032) & (Units)

Table 83: Key Wafer Bonding Equipment Players in Middle East & Africa

Table 84: Middle East & Africa Wafer Bonding Equipment Sales by Type (2020-2025) & (Units)

Table 85: Middle East & Africa Wafer Bonding Equipment Sales by Type (2026-2032) & (Units)

Table 86: Middle East & Africa Wafer Bonding Equipment Revenue by Type

(2020-2025) & (US\$ Million)

Table 87: Middle East & Africa Wafer Bonding Equipment Revenue by Type

(2026-2032) & (US\$ Million)

Table 88: Middle East & Africa Wafer Bonding Equipment Sales by Application

(2020-2025) & (Units)

Table 89: Middle East & Africa Wafer Bonding Equipment Sales by Application

(2026-2032) & (Units)

Table 90: Middle East & Africa Wafer Bonding Equipment Revenue by Application

(2020-2025) & (US\$ Million)

Table 91: Middle East & Africa Wafer Bonding Equipment Revenue by Application

(2026-2032) & (US\$ Million)

Table 92: Middle East & Africa Wafer Bonding Equipment Revenue Market Size by Country (2020-2025) & (US\$ Million)

Table 93: Middle East & Africa Wafer Bonding Equipment Revenue Market Size Forecast by Country (2026-2032) & (US\$ Million)

Table 94: Middle East & Africa Wafer Bonding Equipment Sales Market Size by Country (2020-2025) & (Units)

Table 95: Middle East & Africa Wafer Bonding Equipment Sales Market Size Forecast by Country (2026-2032) & (Units)

Table 96: Global Wafer Bonding Equipment Market Sales by Key Manufacturers (2021-2025) & (Units)

Table 97: Global Wafer Bonding Equipment Sales Market Share by Key Manufacturers (2021-2025)

Table 98: Global Wafer Bonding Equipment Market Revenue by Key Manufacturers (2021-2025) & (US\$ Million)

Table 99: Global Wafer Bonding Equipment Revenue Market Share by Key Manufacturers (2021-2025)

Table 100: Global Average Sales Price by Manufacturers (2021-2025) & (USD/Unit)

Table 101: Global Key Manufacturers Headquarter Location and Key Area Sales

Table 102: Market Mergers & Acquisitions, Expansion

Table 103: EV Group Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 104: EV Group Wafer Bonding Equipment Product Portfolio

Table 105: EV Group Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 106: SUSS MicroTec Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 107: SUSS MicroTec Wafer Bonding Equipment Product Portfolio

Table 108: SUSS MicroTec Wafer Bonding Equipment Revenue (US\$ Million), Sales

(Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 109: Tokyo Electron Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 110: Tokyo Electron Wafer Bonding Equipment Product Portfolio

Table 111: Tokyo Electron Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 112: Applied Microengineering Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 113: Applied Microengineering Wafer Bonding Equipment Product Portfolio

Table 114: Applied Microengineering Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 115: Nidec Machinetool Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 116: Nidec Machinetool Wafer Bonding Equipment Product Portfolio

Table 117: Nidec Machinetool Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 118: Ayumi Industry Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 119: Ayumi Industry Wafer Bonding Equipment Product Portfolio

Table 120: Ayumi Industry Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 121: Shanghai Micro Electronics Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 122: Shanghai Micro Electronics Wafer Bonding Equipment Product Portfolio

Table 123: Shanghai Micro Electronics Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 124: U-Precision Tech Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 125: U-Precision Tech Wafer Bonding Equipment Product Portfolio

Table 126: U-Precision Tech Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 127: Hutem Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 128: Hutem Wafer Bonding Equipment Product Portfolio

Table 129: Hutem Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 130: Canon Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 131: Canon Wafer Bonding Equipment Product Portfolio

Table 132: Canon Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 133: Bondtech Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 134: Bondtech Wafer Bonding Equipment Product Portfolio

Table 135: Bondtech Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 136: TAZMO Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 137: TAZMO Wafer Bonding Equipment Product Portfolio

Table 138: TAZMO Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 139: TOK Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 140: TOK Wafer Bonding Equipment Product Portfolio

Table 141: TOK Wafer Bonding Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 142: Upstream Key Raw Material Price List

Table 143: Wafer Bonding Equipment Raw Material Suppliers and Contact Information

Table 144: Wafer Bonding Equipment Typical Customer List

Table 145: Wafer Bonding Equipment Distributors List

## List Of Figures

### LIST OF FIGURES

- Figure 1: Wafer Bonding Equipment Product Pictures
- Figure 2: Fully Automatic Equipment Picture Scope
- Figure 3: Semi Automatic Equipment Picture Scope
- Figure 4: MEMS Picture Scope
- Figure 5: Advanced Packaging Picture Scope
- Figure 6: CIS Picture Scope
- Figure 7: Others Picture Scope
- Figure 8: Global Wafer Bonding Equipment Market Size Analysis: 2024 VS 2025 VS 2032 (US\$ Million)
- Figure 9: Global Wafer Bonding Equipment Market Revenue and Growth Rate Analysis: (2020-2032) & (US\$ Million)
- Figure 10: Global Wafer Bonding Equipment Market Sales and Growth Rate Analysis (2020-2032) & (Units)
- Figure 11: Global Wafer Bonding Equipment Market Price Trend Analysis (2020-2032) & (USD/Unit)
- Figure 12: Global Wafer Bonding Equipment Market Size by Region (2020-2032) & (US\$ Million)
- Figure 13: Global Wafer Bonding Equipment Market Share Scenario by Region in Percentage: 2025 Versus 2032
- Figure 14: Global Wafer Bonding Equipment Sales Price by Region (2020-2032) & (Units)
- Figure 15: North America Wafer Bonding Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)
- Figure 16: North America Wafer Bonding Equipment Revenue Market Share by Players in 2024
- Figure 17: North America Wafer Bonding Equipment Sales Market Share by Type (2020-2032)
- Figure 18: North America Wafer Bonding Equipment Revenue Market Share by Type (2020-2032)
- Figure 19: North America Wafer Bonding Equipment Sales Market Share by Application (2020-2032)
- Figure 20: North America Wafer Bonding Equipment Revenue Market Share by Application (2020-2032)
- Figure 21: US Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 22: Canada Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)

Figure 23:Europe Wafer Bonding Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)

Figure 24:Europe Wafer Bonding Equipment Revenue Market Share by Players in 2024

Figure 25:Europe Wafer Bonding Equipment Sales Market Share by Type (2020-2032)

Figure 26:Europe Wafer Bonding Equipment Revenue Market Share by Type (2020-2032)

Figure 27:Europe Wafer Bonding Equipment Sales Market Share by Application (2020-2032)

Figure 28:Europe Wafer Bonding Equipment Revenue Market Share by Application (2020-2032)

Figure 29:Germany Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)

Figure 30:France Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)

Figure 31:United Kingdom Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)

Figure 32:Italy Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)

Figure 33:Spain Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)

Figure 34:Benelux Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)

Figure 35:China Wafer Bonding Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)

Figure 36:China Wafer Bonding Equipment Revenue Market Share by Players in 2024

Figure 37:China Wafer Bonding Equipment Sales Market Share by Type (2020-2032)

Figure 38:China Wafer Bonding Equipment Revenue Market Share by Type (2020-2032)

Figure 39:China Wafer Bonding Equipment Sales Market Share by Application (2020-2032)

Figure 40:China Wafer Bonding Equipment Revenue Market Share by Application (2020-2032)

Figure 41:APAC (excl. China) Wafer Bonding Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)

Figure 42:APAC (excl. China) Wafer Bonding Equipment Revenue Market Share by Players in 2024

Figure 43:APAC (excl. China) Wafer Bonding Equipment Sales Market Share by Type (2020-2032)

Figure 44:APAC (excl. China) Wafer Bonding Equipment Revenue Market Share by Type (2020-2032)

Figure 45:APAC (excl. China) Wafer Bonding Equipment Sales Market Share by Application (2020-2032)

Figure 46:APAC (excl. China) Wafer Bonding Equipment Revenue Market Share by Application (2020-2032)

- Figure 47:Japan Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 48:South Korea Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 49:India Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 50:Australia Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 51:Southeast Asia Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 52:Latin America Wafer Bonding Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)
- Figure 53:Latin America Wafer Bonding Equipment Revenue Market Share by Players in 2024
- Figure 54:Latin America Wafer Bonding Equipment Sales Market Share by Type (2020-2032)
- Figure 55:Latin America Wafer Bonding Equipment Revenue Market Share by Type (2020-2032)
- Figure 56:Latin America Wafer Bonding Equipment Sales Market Share by Application (2020-2032)
- Figure 57:Latin America Wafer Bonding Equipment Revenue Market Share by Application (2020-2032)
- Figure 58:Mexico Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 59:Brazil Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 60:Middle East & Africa Wafer Bonding Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)
- Figure 61:Middle East & Africa Wafer Bonding Equipment Revenue Market Share by Players in 2024
- Figure 62:Middle East & Africa Wafer Bonding Equipment Sales Market Share by Type (2020-2032)
- Figure 63:Middle East & Africa Wafer Bonding Equipment Revenue Market Share by Type (2020-2032)
- Figure 64:Middle East & Africa Wafer Bonding Equipment Sales Market Share by Application (2020-2032)
- Figure 65:Middle East & Africa Wafer Bonding Equipment Revenue Market Share by Application (2020-2032)
- Figure 66:Saudi Arabia Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 67:South Africa Wafer Bonding Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 68:Global Wafer Bonding Equipment Sales Market Share by Key Manufacturers in 2024
- Figure 69:Global Wafer Bonding Equipment Revenue Market Share by Key Manufacturers in 2024

Figure 70:Global Wafer Bonding Equipment Industry Competition Landscape

Figure 71:Wafer Bonding Equipment Industry Chain Analysis

Figure 72:Bottom-Up and Top-Down Research Methods

Figure 73:Key Interview Objectives

Figure 74:Data Cross Validation

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